

Serial E<sup>2</sup>PROM

FEATURES

- 2.7V to 5.5V Power Supply
- Low Power CMOS
  - Active Read Current Less Than 1 mA
  - Active Write Current Less Than 3 mA
  - Standby Current Less Than 50  $\mu$ A
- Internally Organized 2048 x 8
- 2 Wire Serial Interface
  - Bidirectional Data Transfer Protocol
- Sixteen Byte Page Write Mode
  - Minimizes Total Write Time Per Byte
- Self Timed Write Cycle
  - Typical Write Cycle Time of 5 ms
- High Reliability
  - Endurance: 100,000 Cycles
  - Data Retention: 100 Years
- 8 Pin Mini-DIP, 8 Pin SOIC and 14 Pin SOIC Packages

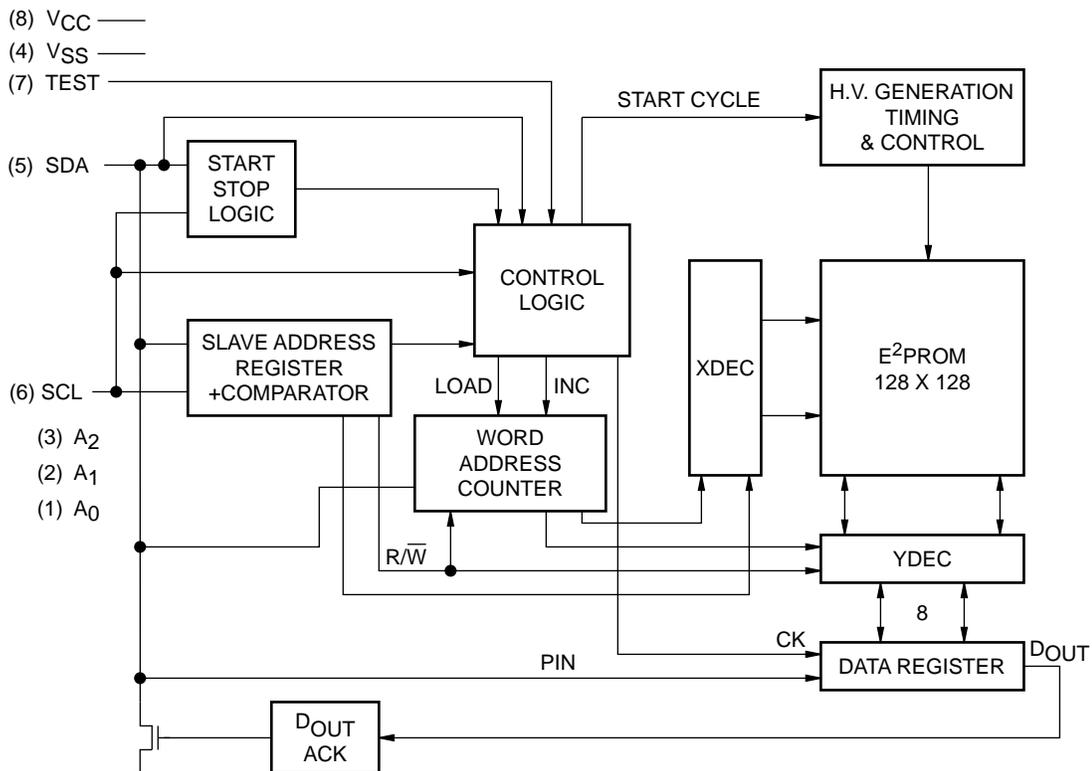
DESCRIPTION

The X24C16 is a CMOS 16,384 bit serial E<sup>2</sup>PROM, internally organized 2048 X 8. The X24C16 features a serial interface and software protocol allowing operation on a simple two wire bus.

The X24C16 is fabricated with Xicor's advanced CMOS Textured Poly Floating Gate Technology.

The X24C16 utilizes Xicor's proprietary Direct Write™ cell providing a minimum endurance of 100,000 cycles and a minimum data retention of 100 years.

FUNCTIONAL DIAGRAM



3840 FHD F01

# X24C16

## PIN DESCRIPTIONS

### Serial Clock (SCL)

The SCL input is used to clock all data into and out of the device.

### Serial Data (SDA)

SDA is a bidirectional pin used to transfer data into and out of the device. It is an open drain output and may be wire-ORed with any number of open drain or open collector outputs.

An open drain output requires the use of a pull-up resistor. For selecting typical values, refer to the Pull-Up Resistor selection graph at the end of this data sheet.

### Address (A<sub>0</sub>, A<sub>1</sub>, A<sub>2</sub>)

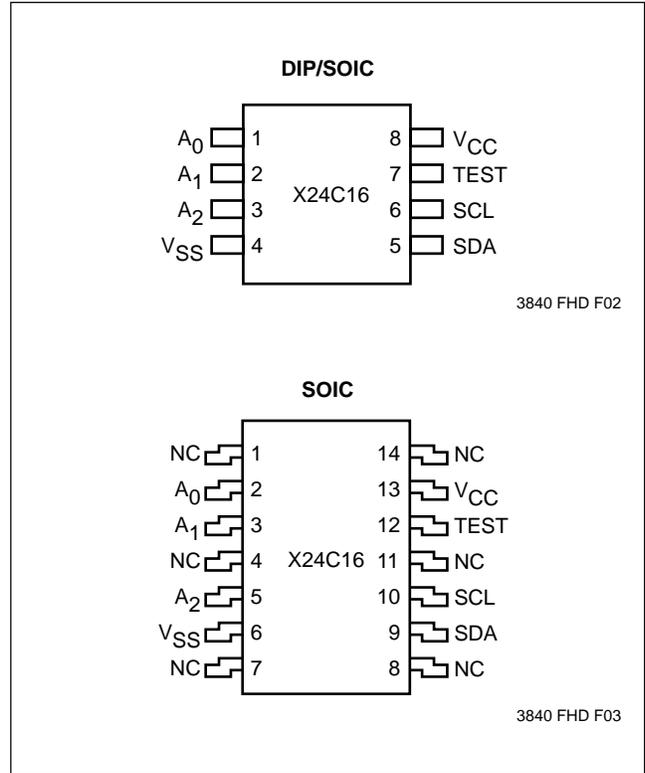
The A<sub>0</sub>, A<sub>1</sub> and A<sub>2</sub> inputs are unused by the X24C16, however, they must be tied to V<sub>SS</sub> to insure proper device operation.

## PIN NAMES

Symbol	Description
A <sub>0</sub> -A <sub>2</sub>	Address Inputs
SDA	Serial Data
SCL	Serial Clock
TEST	Hold at V <sub>SS</sub>
V <sub>SS</sub>	Ground
V <sub>CC</sub>	Supply Voltage
NC	No Connect

3840 PGM T01

## PIN CONFIGURATION



# X24C16

---

## DEVICE OPERATION

The X24C16 supports a bidirectional bus oriented protocol. The protocol defines any device that sends data onto the bus as a transmitter, and the receiving device as the receiver. The device controlling the transfer is a master and the device being controlled is the slave. The master will always initiate data transfers, and provide the clock for both transmit and receive operations. Therefore, the X24C16 will be considered a slave in all applications.

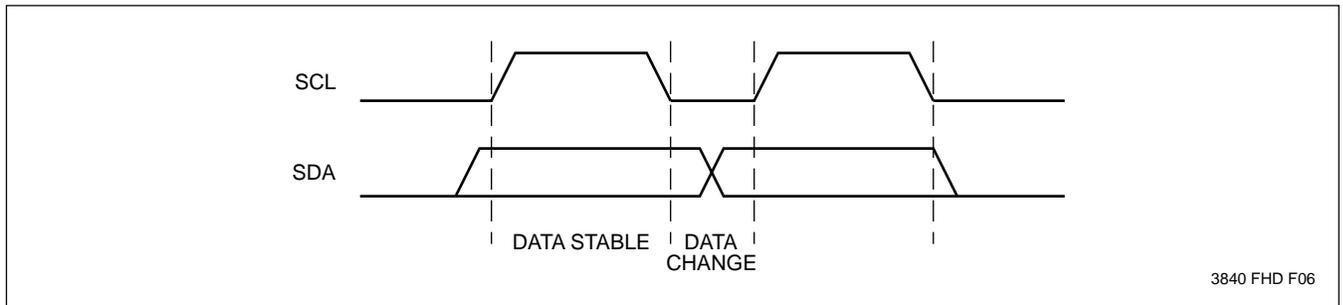
## Clock and Data Conventions

Data states on the SDA line can change only during SCL LOW. SDA state changes during SCL HIGH are reserved for indicating start and stop conditions. Refer to Figures 1 and 2.

### Start Condition

All commands are preceded by the start condition, which is a HIGH to LOW transition of SDA when SCL is HIGH. The X24C16 continuously monitors the SDA and SCL lines for the start condition and will not respond to any command until this condition has been met.

**Figure 1. Data Validity**



# X24C16

## Stop Condition

All communications must be terminated by a stop condition, which is a LOW to HIGH transition of SDA when SCL is HIGH. The stop condition is also used by the X24C16 to place the device into the standby power mode after a read sequence. A stop condition can only be issued after the transmitting device has released the bus.

## Acknowledge

Acknowledge is a software convention used to indicate successful data transfer. The transmitting device, either master or slave, will release the bus after transmitting eight bits. During the ninth clock cycle the receiver will pull the SDA line LOW to acknowledge that it received the eight bits of data. Refer to Figure 3.

The X24C16 will respond with an acknowledge after recognition of a start condition and its slave address. If both the device and a write operation have been selected, the X24C16 will respond with an acknowledge after the receipt of each subsequent eight bit word.

In the read mode the X24C16 will transmit eight bits of data, release the SDA line and monitor the line for an acknowledge. If an acknowledge is detected and no stop condition is generated by the master, the X24C16 will continue to transmit data. If an acknowledge is not detected, the X24C16 will terminate further data transmissions. The master must then issue a stop condition to return the X24C16 to the standby power mode and place the device into a known state.

Figure 2. Definition of Start and Stop

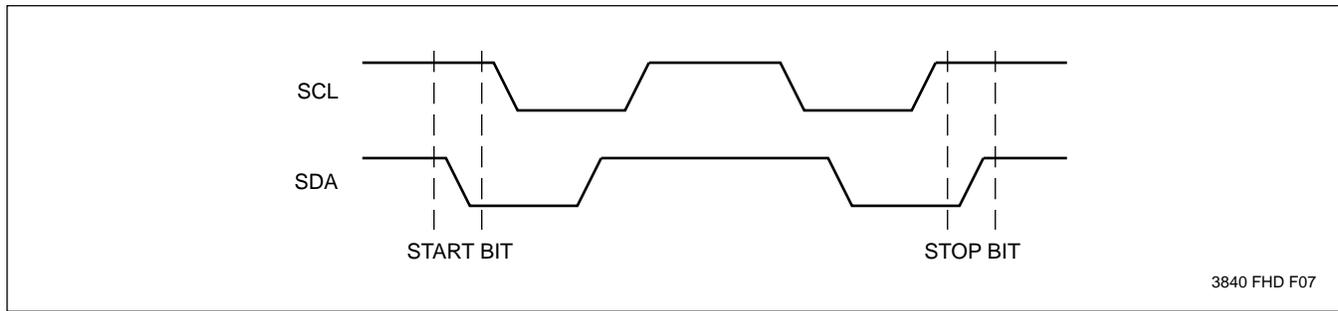
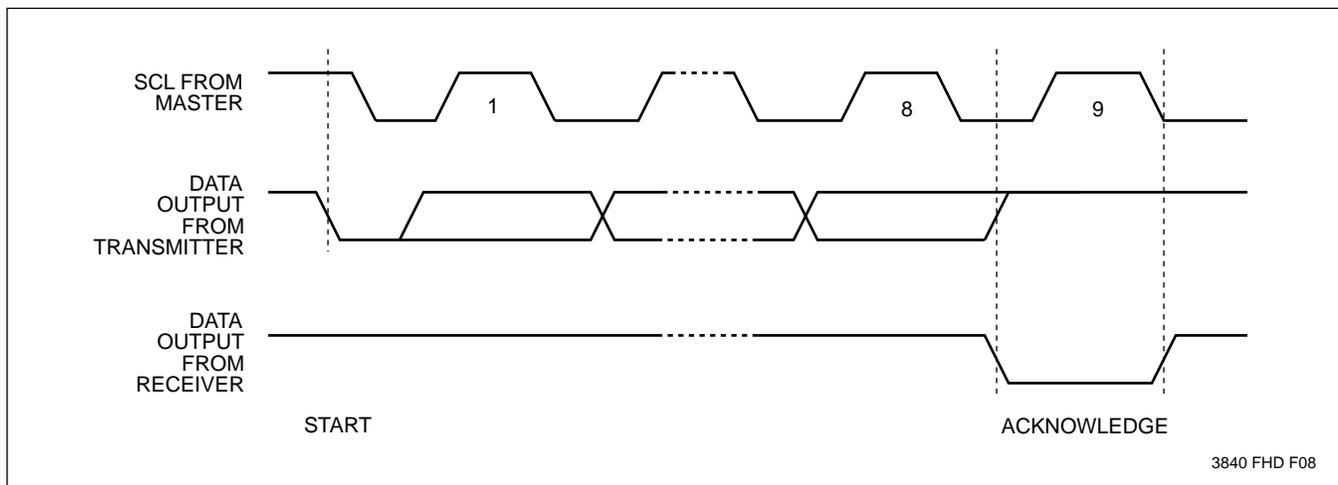


Figure 3. Acknowledge Response From Receiver

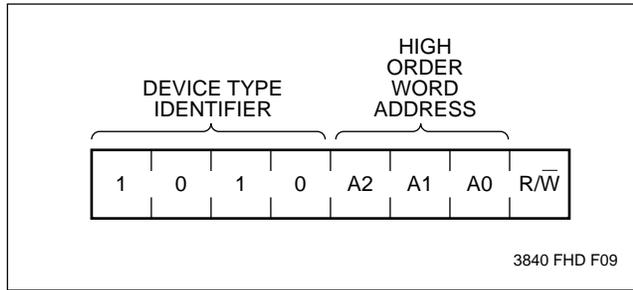


# X24C16

## DEVICE ADDRESSING

Following a start condition the master must output the address of the slave it is accessing. The most significant four bits of the slave address are the device type identifier (see Figure 4). For the X24C16 this is fixed as 1010[B].

Figure 4. Slave Address



The next three bits of the slave address field are the bank select bits. They are used by the host to toggle between the eight 256 x 8 banks of memory. These are, in effect, the most significant bits for the word address.

The next three bits of the slave address are an extension of the array's address and are concatenated with the

eight bits of address in the word address field, providing direct access to the whole 2048 x 8 array.

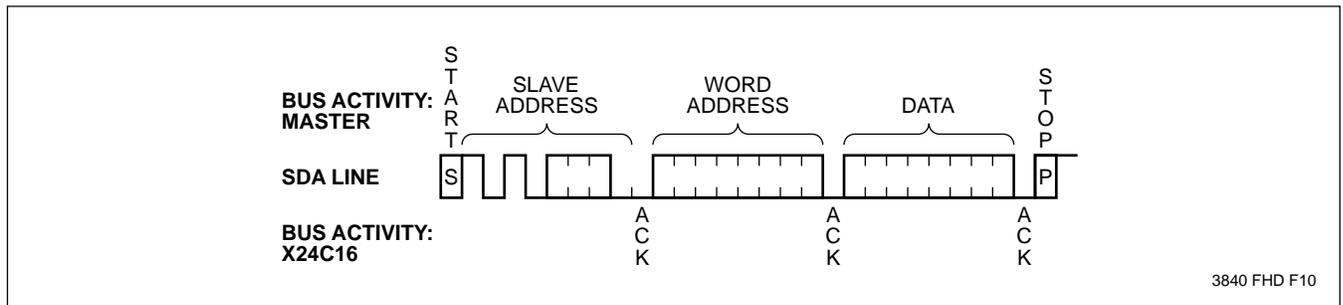
Following the start condition, the X24C16 monitors the SDA bus comparing the slave address being transmitted with its slave address (device type). Upon a correct compare the X24C16 outputs an acknowledge on the SDA line. Depending on the state of the R/W bit, the X24C16 will execute a read or write operation.

## WRITE OPERATIONS

### Byte Write

For a write operation, the X24C16 requires a second address field. This address field is the word address, comprised of eight bits, providing access to any one of the 2048 words in the array. Upon receipt of the word address the X24C16 responds with an acknowledge, and awaits the next eight bits of data, again responding with an acknowledge. The master then terminates the transfer by generating a stop condition, at which time the X24C16 begins the internal write cycle to the nonvolatile memory. While the internal write cycle is in progress the X24C16 inputs are disabled, and the device will not respond to any requests from the master. Refer to Figure 5 for the address, acknowledge and data transfer sequence.

Figure 5. Byte Write



# X24C16

## Page Write

The X24C16 is capable of a sixteen byte page write operation. It is initiated in the same manner as the byte write operation, but instead of terminating the write cycle after the first data word is transferred, the master can transmit up to fifteen more words. After the receipt of each word, the X24C16 will respond with an acknowledge.

After the receipt of each word, the four low order address bits are internally incremented by one. The high order seven bits of the address remain constant. If the master should transmit more than sixteen words prior to generating the stop condition, the address counter will “roll over” and the previously written data will be overwritten. As with the byte write operation, all inputs are disabled until completion of the internal write cycle. Refer to Figure 6 for the address, acknowledge and data transfer sequence.

## Acknowledge Polling

The disabling of the inputs can be used to take advantage of the typical 5 ms write cycle time. Once the stop condition is issued to indicate the end of the host’s write operation the X24C16 initiates the internal write cycle. ACK polling can be initiated immediately. This involves issuing the start condition followed by the slave address for a write operation. If the X24C16 is still busy with the write operation no ACK will be returned. If the X24C16 has completed the write operation an ACK will be returned and the host can then proceed with the next read or write operation. Refer to Flow 1.

Flow 1. ACK Polling Sequence

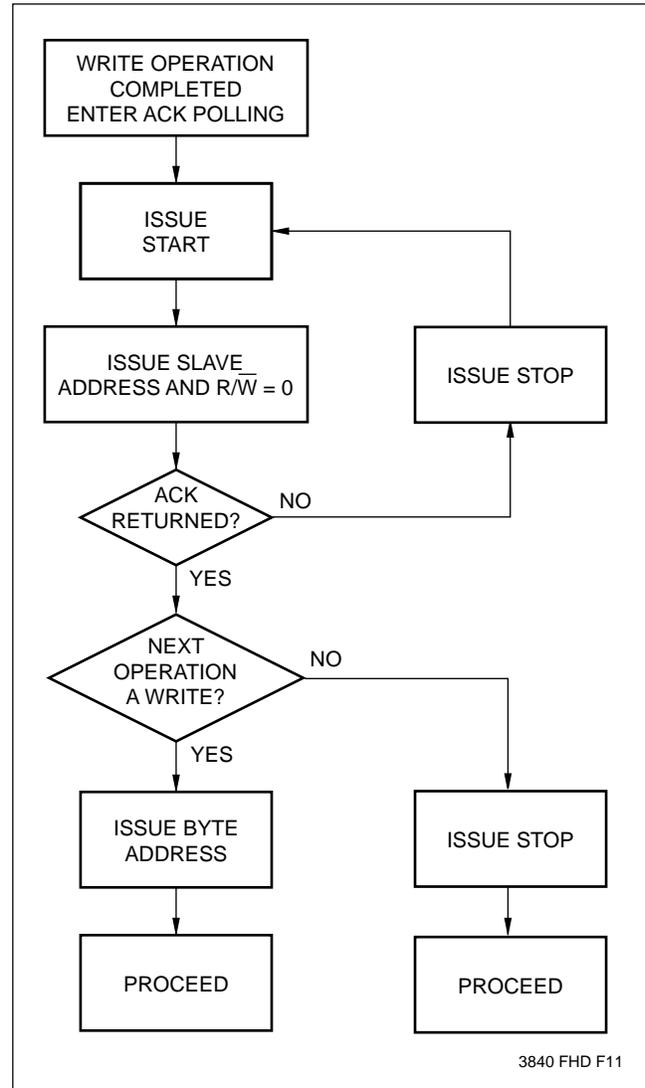
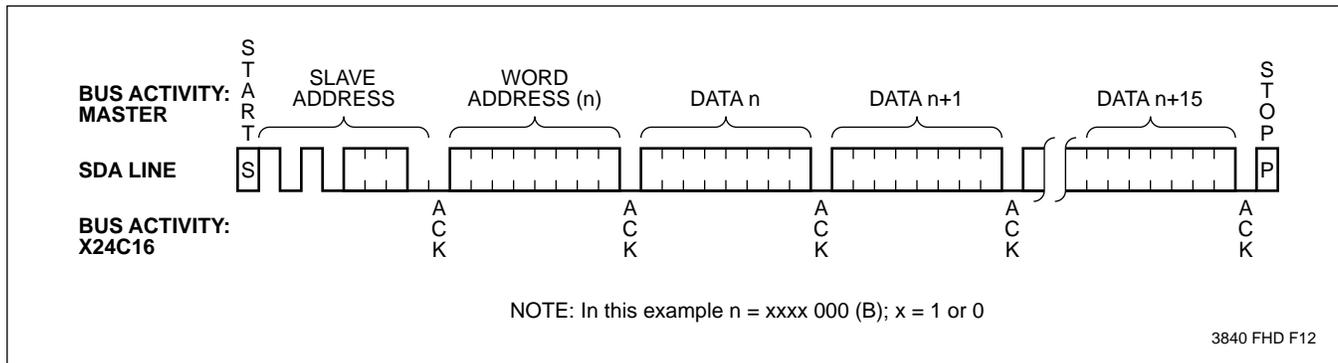


Figure 6. Page Write



# X24C16

## READ OPERATIONS

Read operations are initiated in the same manner as write operations with the exception that the  $\overline{R/W}$  bit of the slave address is set to a one. There are three basic read operations: current address read, random read and sequential read.

It should be noted that the ninth clock cycle of the read operation is not a “don’t care.” To terminate a read operation, the master must either issue a stop condition during the ninth cycle or hold SDA HIGH during the ninth clock cycle and then issue a stop condition.

### Current Address Read

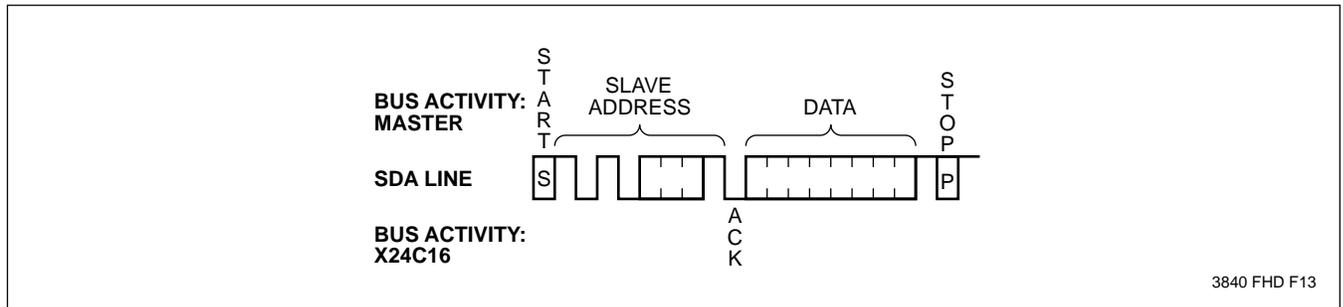
Internally the X24C16 contains an address counter that maintains the address of the last word accessed, incremented by one. Therefore, if the last access (either a read or write) was to address  $n$ , the next read operation would access data from address  $n + 1$ . Upon receipt of the slave address with the  $\overline{R/W}$  bit set to one, the X24C16 issues an acknowledge and transmits the eight

bit word. The read operation is terminated by the master; by not responding with an acknowledge and by issuing a stop condition. Refer to Figure 7 for the sequence of address, acknowledge and data transfer.

### Random Read

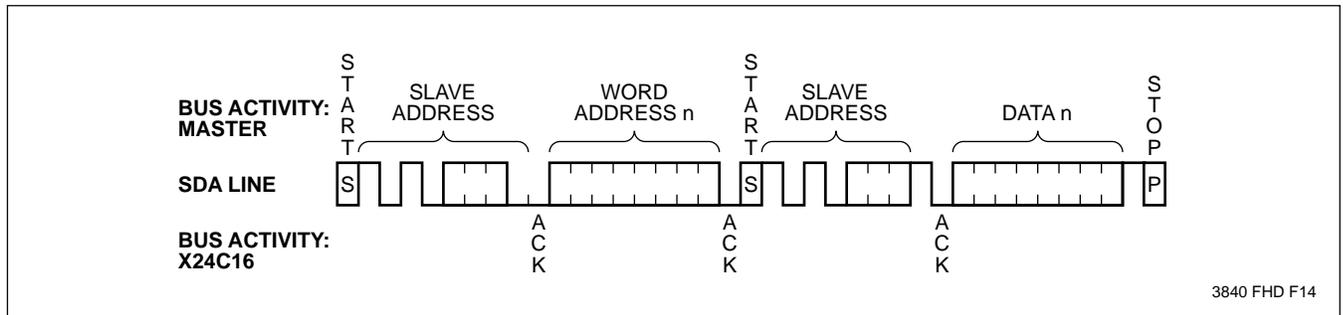
Random read operations allow the master to access any memory location in a random manner. Prior to issuing the slave address with the  $\overline{R/W}$  bit set to one, the master must first perform a “dummy” write operation. The master issues the start condition, and the slave address followed by the word address it is to read. After the word address acknowledge, the master immediately reissues the start condition and the slave address with the  $\overline{R/W}$  bit set to one. This will be followed by an acknowledge from the X24C16 and then by the eight bit word. The read operation is terminated by the master; by not responding with an acknowledge and by issuing a stop condition. Refer to Figure 8 for the address, acknowledge and data transfer sequence.

Figure 7. Current Address Read



3840 FHD F13

Figure 8. Random Read



3840 FHD F14

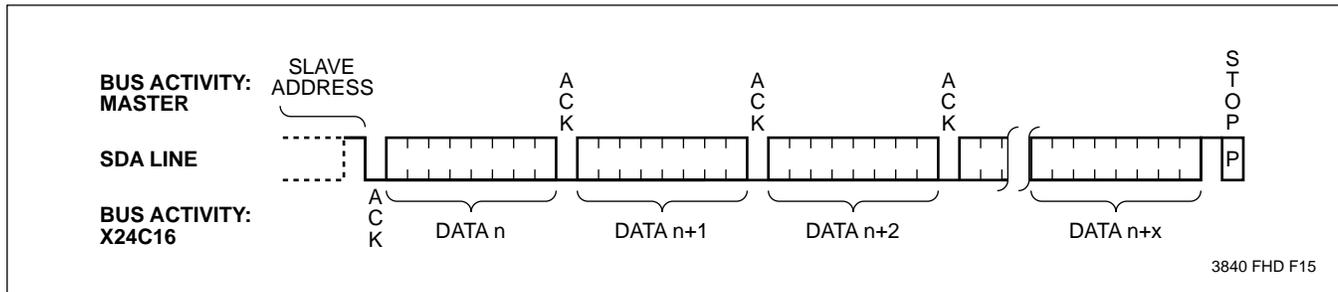
# X24C16

## Sequential Read

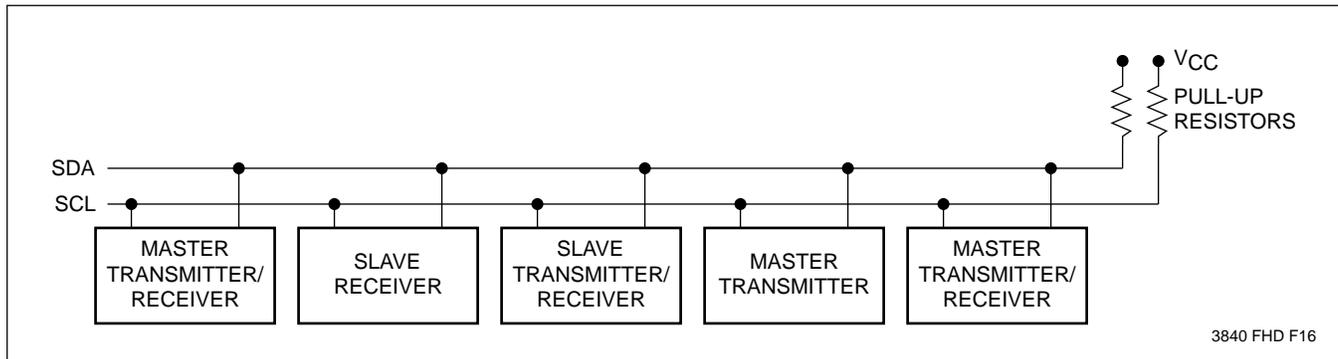
Sequential reads can be initiated as either a current address read or random access read. The first word is transmitted as with the other read modes, however, the master now responds with an acknowledge, indicating it requires additional data. The X24C16 continues to output data for each acknowledge received. The read operation is terminated by the master; by not responding with an acknowledge and by issuing a stop condition.

The data output is sequential, with the data from address  $n$  followed by the data from  $n + 1$ . The address counter for read operations increments all address bits, allowing the entire memory contents to be serially read during one operation. At the end of the address space (address 2047), the counter “rolls over” to 0 and the X24C16 continues to output data for each acknowledge received. Refer to Figure 9 for the address, acknowledge and data transfer sequence.

**Figure 9. Sequential Read**



**Figure 10. Typical System Configuration**



# X24C16

## ABSOLUTE MAXIMUM RATINGS\*

Temperature Under Bias .....	-65°C to +135°C
Storage Temperature .....	-65°C to +150°C
Voltage on any Pin with Respect to $V_{SS}$ .....	-1.0V to +7.0V
D.C. Output Current .....	5 mA
Lead Temperature (Soldering, 10 Seconds) .....	300°C

## \*COMMENT

Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and the functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## RECOMMENDED OPERATING CONDITIONS

Temperature	Min.	Max.
Commercial	0°C	70°C
Industrial	-40°C	+85°C
Military	-55°C	+125°C

3840 PGM T09

Supply Voltage	Limits
X24C16	4.5V to 5.5V
X24C16-3.5	3.5V to 5.5V
X24C16-3	3V to 5.5V
X24C16-2.7	2.7V to 5.5V

3840 PGM T10

## D.C. OPERATING CHARACTERISTICS (Over the recommended operating conditions, unless otherwise specified)

Symbol	Parameter	Limits		Units	Test Conditions
		Min.	Max.		
$I_{CC1}$	$V_{CC}$ Supply Current (read)		1	mA	SCL = $V_{CC} \times 0.1/V_{CC} \times 0.9$ Levels @ 100 KHz, SDA = Open, All Other Inputs = GND or $V_{CC} - 0.3V$
$I_{CC2}$	$V_{CC}$ Supply Current (write)		3		
$I_{SB1}^{(1)}$	$V_{CC}$ Standby Current		150	$\mu A$	SCL = SDA = $V_{CC} - 0.3V$ , All Other Inputs = GND or $V_{CC}$ , $V_{CC} = 5.5V$
$I_{SB2}^{(1)}$	$V_{CC}$ Standby Current		50	$\mu A$	SCL = SDA = $V_{CC} - 0.3V$ , All Other Inputs = GND or $V_{CC}$ , $V_{CC} = 3.3V + 10\%$
$I_{LI}$	Input Leakage Current		10	$\mu A$	$V_{IN} = GND$ to $V_{CC}$
$I_{LO}$	Output Leakage Current		10	$\mu A$	$V_{OUT} = GND$ to $V_{CC}$
$V_{IL}^{(2)}$	Input Low Voltage	-1.0	$V_{CC} \times 0.3$	V	
$V_{IH}^{(2)}$	Input High Voltage	$V_{CC} \times 0.7$	$V_{CC} + 0.5$	V	
$V_{OL}$	Output Low Voltage		0.4	V	$I_{OL} = 3 mA$

3840 PGM T03

## CAPACITANCE $T_A = 25^\circ C$ , $f = 1.0 MHz$ , $V_{CC} = 5V$

Symbol	Parameter	Max.	Units	Test Conditions
$C_{I/O}^{(3)}$	Input/Output Capacitance (SDA)	8	pF	$V_{I/O} = 0V$
$C_{IN}^{(3)}$	Input Capacitance ( $A_0, A_1, A_2, SCL$ )	6	pF	$V_{IN} = 0V$

3840 PGM T05

- Notes:** (1) Must perform a stop command prior to measurement.  
 (2)  $V_{IL}$  min. and  $V_{IH}$  max. are for reference only and are not tested.  
 (3) This parameter is periodically sampled and not 100% tested.

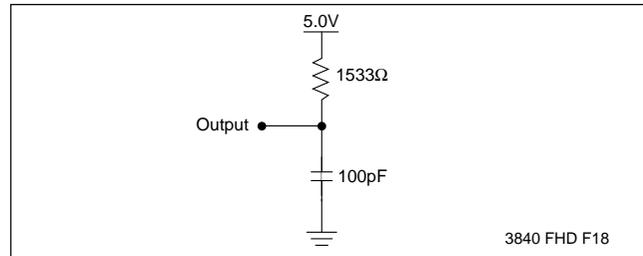
# X24C16

## A.C. CONDITIONS OF TEST

Input Pulse Levels	$V_{CC} \times 0.1$ to $V_{CC} \times 0.9$
Input Rise and Fall Times	10 ns
Input and Output Timing Levels	$V_{CC} \times 0.5$

3840 PGM T02

## EQUIVALENT A.C. LOAD CIRCUIT



3840 FHD F18

## A.C. CHARACTERISTICS LIMITS (Over the recommended operating conditions unless otherwise specified.) Read & Write Cycle Limits

Symbol	Parameter	Min.	Max.	Units
$f_{SCL}$	SCL Clock Frequency	0	100	KHz
$T_I$	Noise Suppression Time Constant at SCL, SDA Inputs		100	ns
$t_{AA}$	SCL Low to SDA Data Out Valid	0.3	3.5	$\mu$ s
$t_{BUF}$	Time the Bus Must Be Free Before a New Transmission Can Start	4.7		$\mu$ s
$t_{HD:STA}$	Start Condition Hold Time	4.0		$\mu$ s
$t_{LOW}$	Clock Low Period	4.7		$\mu$ s
$t_{HIGH}$	Clock High Period	4.0		$\mu$ s
$t_{SU:STA}$	Start Condition Setup Time (for a Repeated Start Condition)	4.7		$\mu$ s
$t_{HD:DAT}$	Data In Hold Time	0		$\mu$ s
$t_{SU:DAT}$	Data In Setup Time	250		ns
$t_R$	SDA and SCL Rise Time		1	$\mu$ s
$t_F$	SDA and SCL Fall Time		300	ns
$t_{SU:STO}$	Stop Condition Setup Time	4.7		$\mu$ s
$t_{DH}$	Data Out Hold Time	300		ns

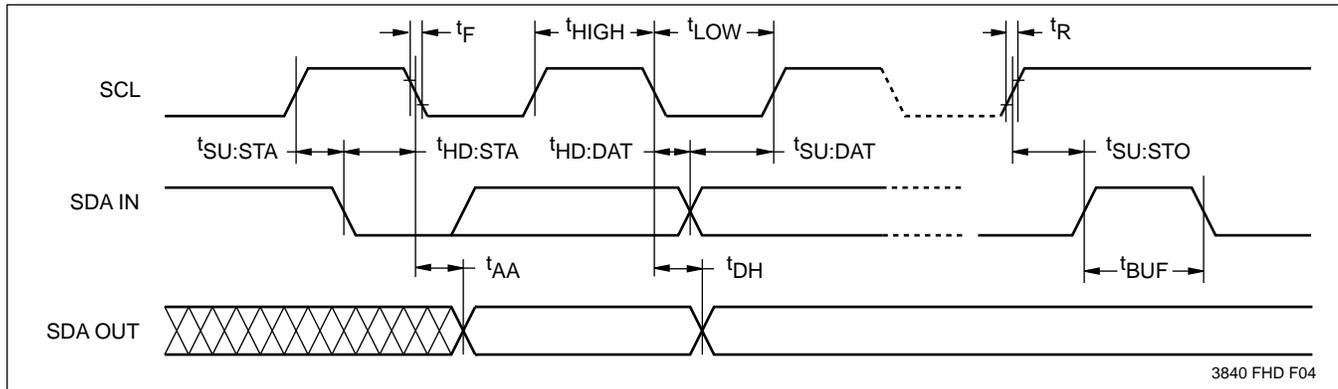
3840 PGM T06

## POWER-UP TIMING

Symbol	Parameter	Max.	Units
$t_{PUR}^{(4)}$	Power-up to Read Operation	1	ms
$t_{PUW}^{(4)}$	Power-up to Write Operation	5	ms

3840 PGM T07

## Bus Timing



3840 FHD F04

**Notes:** (4)  $t_{PUR}$  and  $t_{PUW}$  are the delays required from the time  $V_{CC}$  is stable until the specified operation can be initiated. These parameters are periodically sampled and not 100% tested.

# X24C16

## WRITE CYCLE LIMITS

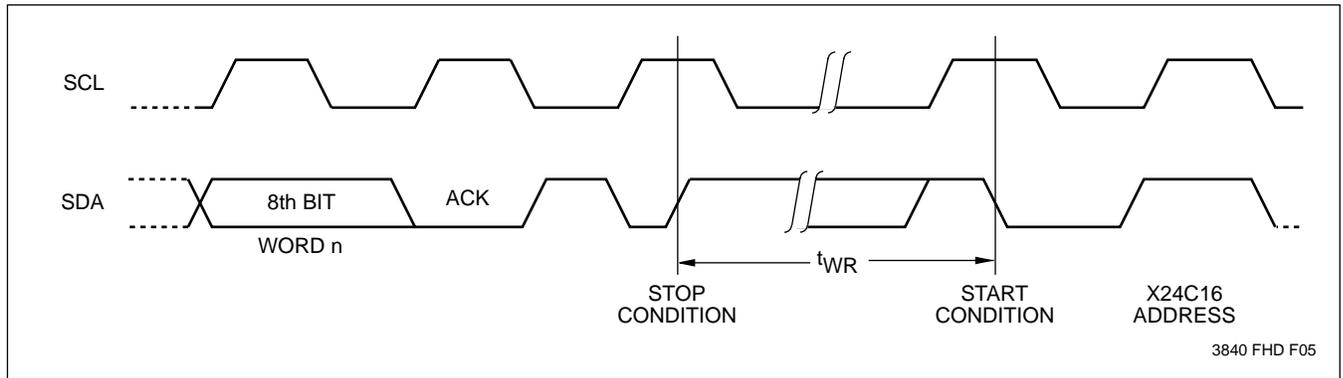
Symbol	Parameter	Min.	Typ.(5)	Max.	Units
$t_{WR}^{(6)}$	Write Cycle Time		5	10	ms

3840 PGM T08

The write cycle time is the time from a valid stop condition of a write sequence to the end of the internal erase/program cycle. During the write cycle, the X24C16

bus interface circuits are disabled, SDA is allowed to remain high, and the device does not respond to its slave address.

## Write Cycle Timing

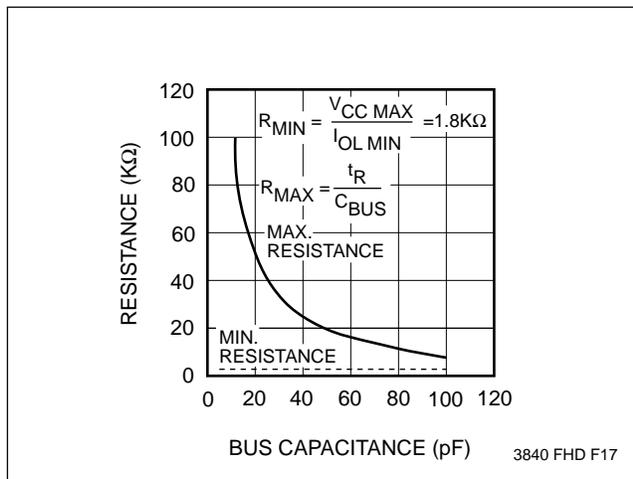


3840 FHD F05

**Notes:** (5) Typical values are for  $T_A = 25^\circ\text{C}$  and nominal supply voltage (5V)

(6)  $t_{WR}$  is the minimum cycle time from the system perspective when polling techniques are not used. It is the maximum time the device requires to perform the internal write operation.

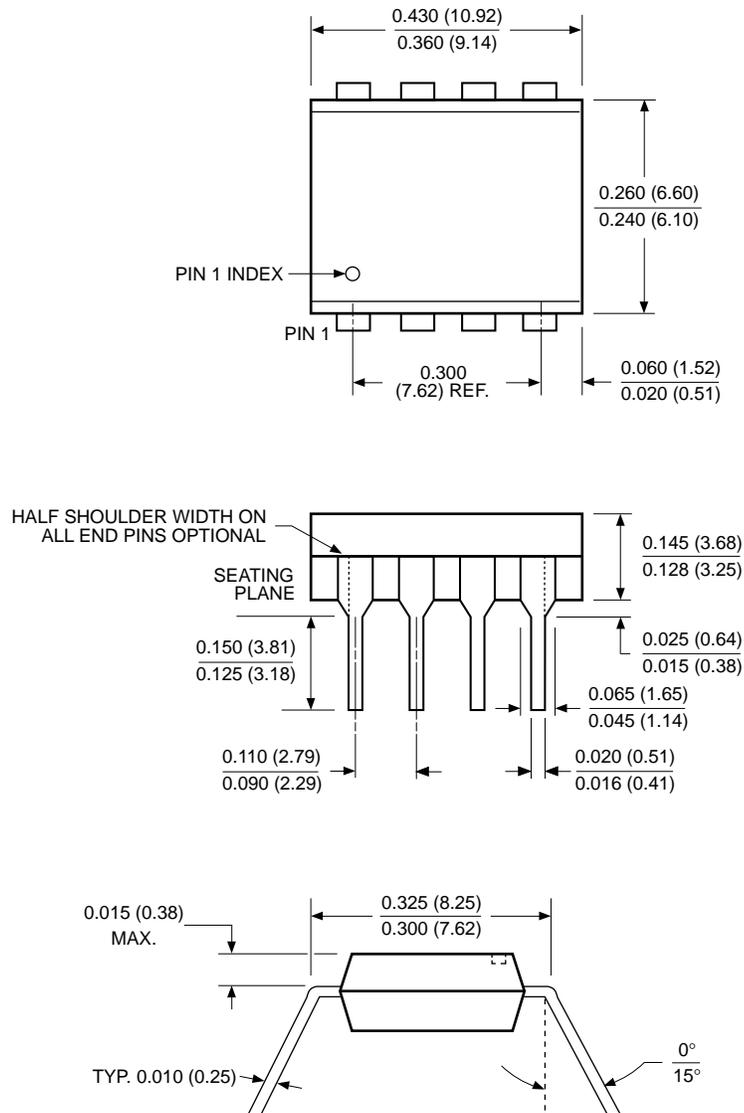
## Guidelines for Calculating Typical Values of Bus Pull-Up Resistors



## SYMBOL TABLE

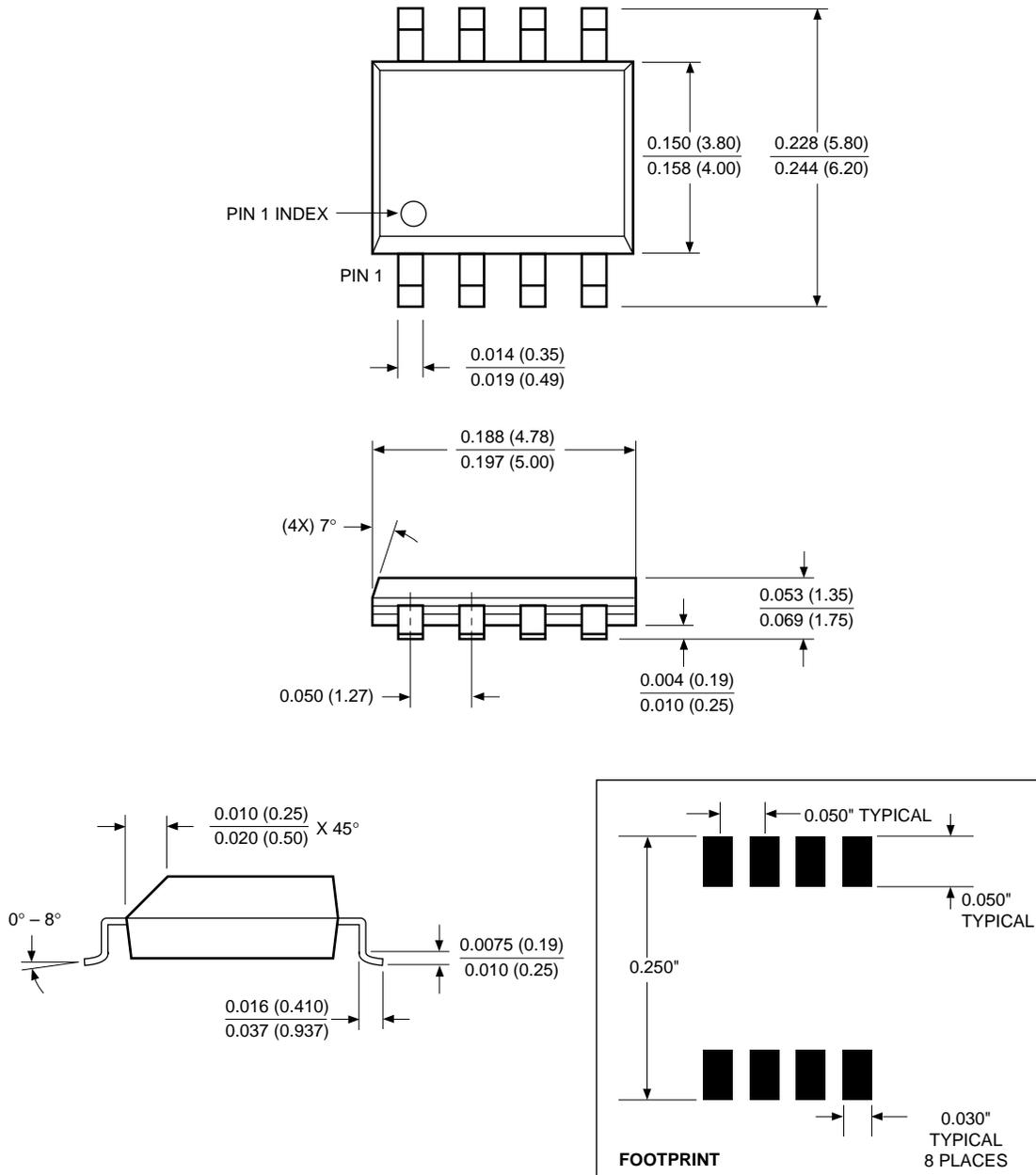
WAVEFORM	INPUTS	OUTPUTS
	Must be steady	Will be steady
	May change from Low to High	Will change from Low to High
	May change from High to Low	Will change from High to Low
	Don't Care: Changes Allowed	Changing: State Not Known
	N/A	Center Line is High Impedance

## 8-LEAD PLASTIC DUAL IN-LINE PACKAGE TYPE P



- NOTE:**
1. ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)
  2. PACKAGE DIMENSIONS EXCLUDE MOLDING FLASH

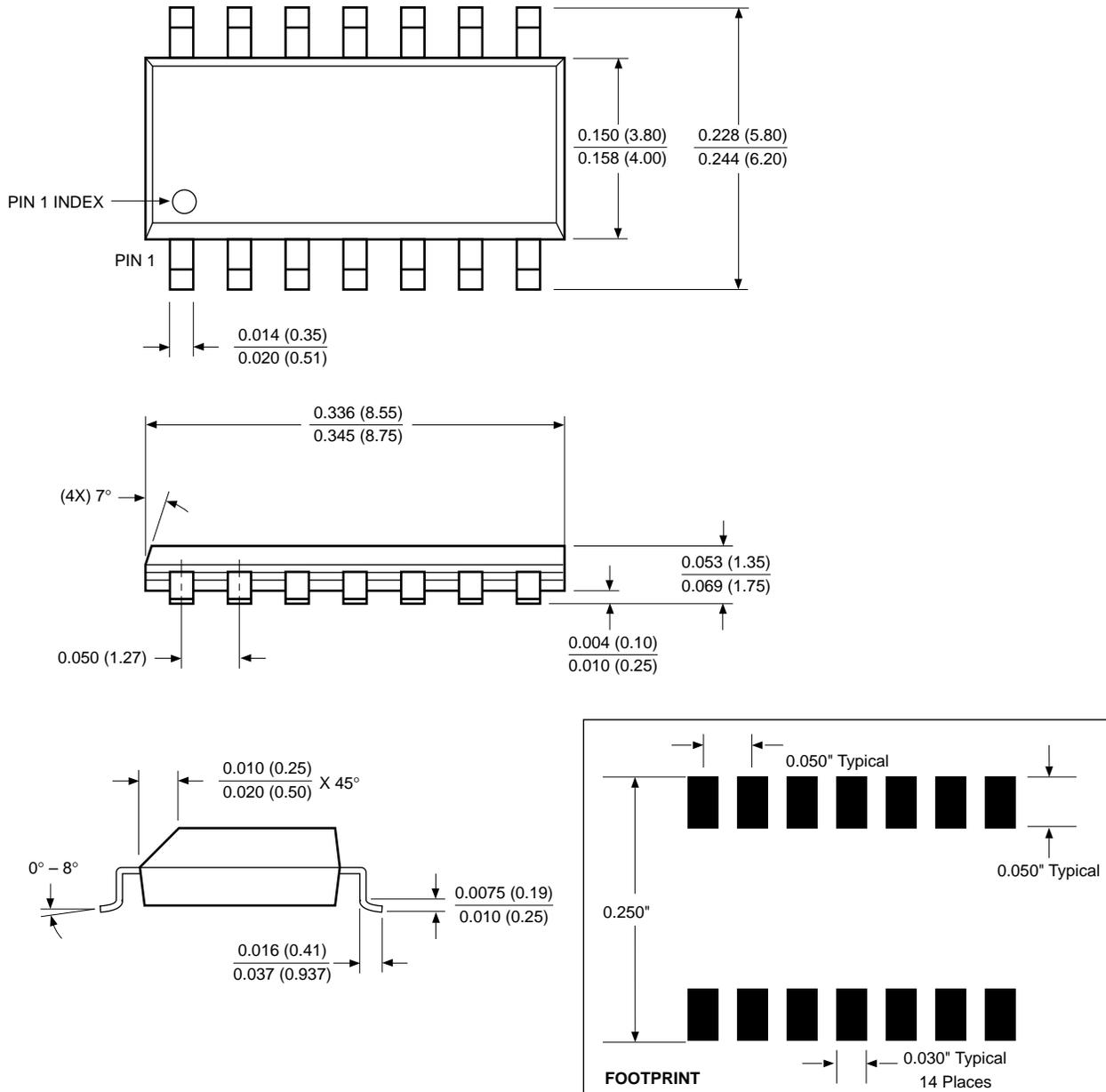
**8-LEAD PLASTIC SMALL OUTLINE GULL WING PACKAGE TYPE S**



**NOTE: ALL DIMENSIONS IN INCHES (IN PARENTHESIS IN MILLIMETERS)**

# X24C16

## 14-LEAD PLASTIC SMALL OUTLINE GULL WING PACKAGE TYPE S

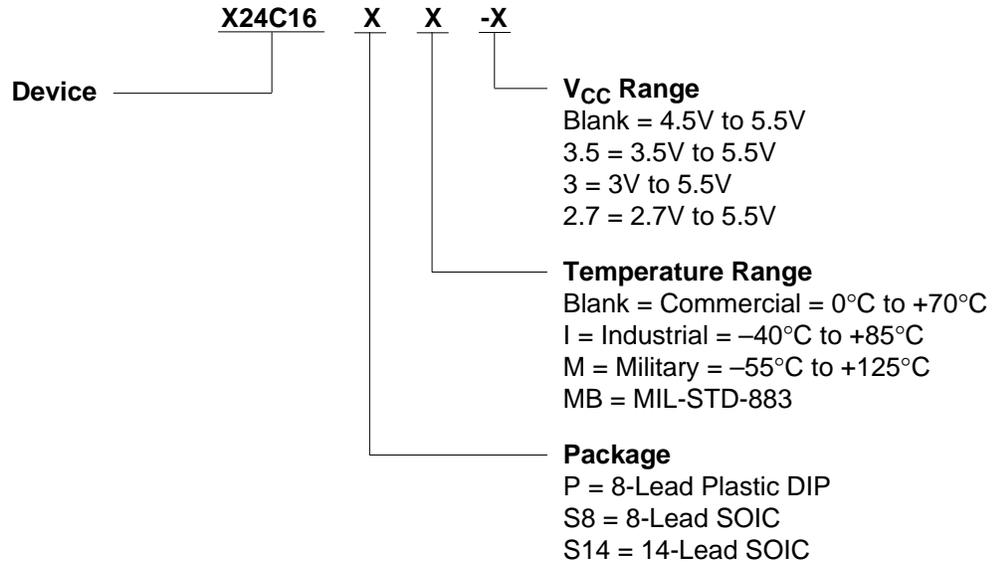


NOTE: ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)

3926 FHD F10

# X24C16

## ORDERING INFORMATION



## Part Mark Convention

<b>X24C16</b>	<b>X</b>	— P = 8-Lead Plastic DIP S8 = 8-Lead SOIC S14 = 14-Lead SOIC
	<b>X</b>	Blank = 4.5V to 5.5V, 0°C to +70°C I = 4.5V to 5.5V, -40°C to +85°C B = 3.5V to 5.5V, 0°C to +70°C C = 3.5V to 5.5V, -40°C to +85°C D = 3.0V to 5.5V, 0°C to +70°C E = 3.0V to 5.5V, -40°C to +85°C F = 2.7V to 5.5V, 0°C to +70°C G = 2.7V to 5.5V, -40°C to +85°C M = 4.5V to 5.5V, -55°C to +125°C

### LIMITED WARRANTY

Devices sold by Xicor, Inc. are covered by the warranty and patent indemnification provisions appearing in its Terms of Sale only. Xicor, Inc. makes no warranty, express, statutory, implied, or by description regarding the information set forth herein or regarding the freedom of the described devices from patent infringement. Xicor, Inc. makes no warranty of merchantability or fitness for any purpose. Xicor, Inc. reserves the right to discontinue production and change specifications and prices at any time and without notice.

Xicor, Inc. assumes no responsibility for the use of any circuitry other than circuitry embodied in a Xicor, Inc. product. No other circuits, patents, licenses are implied.

### US. PATENTS

Xicor products are covered by one or more of the following U.S. Patents: 4,263,664; 4,274,012; 4,300,212; 4,314,265; 4,326,134; 4,393,481; 4,404,475; 4,450,402; 4,486,769; 4,488,060; 4,520,461; 4,533,846; 4,599,706; 4,617,652; 4,668,932; 4,752,912; 4,829,482; 4,874,967; 4,883,976; 4,980,859; 5,012,132; 5,003,197; 5,023,694. Foreign patents and additional patents pending.

### LIFE RELATED POLICY

In situations where semiconductor component failure may endanger life, system designers using this product should design the system with appropriate error detection and correction, redundancy and back-up features to prevent such an occurrence.

Xicor's products are not authorized for use as critical components in life support devices or systems.

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

## U.S. SALES OFFICES

### Corporate Office

Xicor Inc.  
1511 Buckeye Drive  
Milpitas, CA 95035  
Phone: 408/432-8888  
Fax: 408/432-0640  
E-mail: info@smtpgate.xicor.com

### Northeast Region

Xicor Inc.  
1344 Main Street  
Waltham, MA 02154  
Phone: 617/899-5510  
Fax: 617/899-6808  
E-mail: xicor-ne@smtpgate.xicor.com

### Southeast Region

Xicor Inc.  
100 E. Sybelia Ave.  
Suite 355  
Maitland, FL 32751  
Phone: 407/740-8282  
Fax: 407/740-8602  
E-mail: xicor-se@smtpgate.xicor.com

### Mid-Atlantic Region

Xicor Inc.  
50 North Street  
Danbury, CT 06810  
Phone: 203/743-1701  
Fax: 203/794-9501  
E-mail: xicor-ma@smtpgate.xicor.com

### North Central Region

Xicor Inc.  
810 South Bartlett Road  
Suite 103  
Streamwood, IL 60107  
Phone: 708/372-3200  
Fax: 708/372-3210  
E-mail: xicor-nc@smtpgate.xicor.com

### South Central Region

Xicor Inc.  
11884 Greenville Ave.  
Suite 102  
Dallas, TX 75243  
Phone: 214/669-2022  
Fax: 214/644-5835  
E-mail: xicor-sc@smtpgate.xicor.com

### Southwest Region

Xicor Inc.  
4100 Newport Place Drive  
Suite 710  
Newport Beach, CA 92660  
Phone: 714/752-8700  
Fax: 714/752-8634  
E-mail: xicor-sw@smtpgate.xicor.com

### Northwest Region

Xicor Inc.  
2700 Augustine Drive  
Suite 219  
Santa Clara, CA 95054  
Phone: 408/292-2011  
Fax: 408/980-9478  
E-mail: xicor-nw@smtpgate.xicor.com

---

## INTERNATIONAL SALES OFFICES

### EUROPE

#### Northern Europe

Xicor Ltd.  
Grant Thornton House  
Witan Way  
Witney  
Oxford OX8 6FE  
UK  
Phone: (44) 1933.700544  
Fax: (44) 1933.700533  
E-mail: xicor-uk@smtpgate.xicor.com

#### Central Europe

Xicor GmbH  
Technopark Neukeferloh  
Bretonischer Ring 15  
85630 Grasbrunn bei Muenchen  
Germany  
Phone: (49) 8946.10080  
Fax: (49) 8946.05472  
E-mail: xicor-gm@smtpgate.xicor.com

### ASIA/PACIFIC

#### Japan

Xicor Japan K.K.  
Suzuki Building, 4th Floor  
1-6-8 Shinjuku, Shinjuku-ku  
Tokyo 160, Japan  
Phone: (81) 3322.52004  
Fax: (81) 3322.52319  
E-mail: xicor-jp@smtpgate.xicor.com

#### Mainland China

#### Taiwan/Hong Kong

Xicor Inc.  
4100 Newport Place Drive  
Suite 710  
Newport Beach, CA 92660  
Phone: 714/752-8700  
Fax: 714/752-8634  
E-mail: xicor-sw@smtpgate.xicor.com

### Singapore/Malaysia/India

Xicor Inc.  
2700 Augustine Drive  
Suite 219  
Santa Clara, CA 95054  
Phone: 408/292-2011  
Fax: 408/980-9478  
E-mail: xicor-nw@smtpgate.xicor.com

### Korea

Xicor Korea  
27th Fl., Korea World Trade Ctr.  
159, Samsung-dong  
Kangnam Ku  
Seoul 135-729  
Korea  
Phone: (82) 2551.2750  
Fax: (82) 2551.2710  
E-mail: xicor-ka@smtpgate.xicor.com

( ) = Country Code

**Xicor product information is available at:**

**<http://www.xicor.com>**